

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHIH-WEI HSIAO	12/24/2018
HSIU-YUAN HSU	12/24/2018
WEI-CHIH LIN	12/24/2018
SHUO-HSIU HSU	12/24/2018
YEN-HSU KO	12/24/2018
CHIH-CHUNG HSIEH	12/24/2018
CHENG-KAI HUANG	12/24/2018
PAUL CHEN	12/24/2018
GENN-SHENG LEE	12/24/2018
JIA-HAU LIU	12/24/2018
MAO-CHUN WENG	12/24/2018
WAYNE CHOU	12/24/2018
RECEIVING PARTY DATA	
Name:	FU DING PRECISION COMPONENT (SHEN ZHEN) CO., LTD.
Street Address:	Baoyuan Technology Area, By South Guanguang Road,,Longhua District, Shenzhen City, Guangdong Provinc
City:	Shenzhen
State/Country:	CHINA
Name:	FOXCONN INTERCONNECT TECHNOLOGY LIMITED
Street Address:	Floor 4,Willow House,Cricket Square,P O Box 2804
City:	Grand Cayman
State/Country:	CAYMAN ISLANDS
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16238534
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	US72431
NAME OF SUBMITTER:	WEI TE CHUNG
SIGNATURE:	/WEI TE CHUNG/
DATE SIGNED:	01/03/2019

Total Attachments: 3

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ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- | | | | |
|-----|-------------------------|---------------|---------------------------|
| 1. | <u>SHIH-WEI HSIAO</u> | , residing at | <u>New Taipei, Taiwan</u> |
| 2. | <u>HSIU-YUAN HSU</u> | , residing at | <u>New Taipei, Taiwan</u> |
| 3. | <u>WEI-CHIH LIN</u> | , residing at | <u>New Taipei, Taiwan</u> |
| 4. | <u>SHUO-HSIU HSU</u> | , residing at | <u>New Taipei, Taiwan</u> |
| 5. | <u>YEN-HSU KO</u> | , residing at | <u>New Taipei, Taiwan</u> |
| 6. | <u>CHIH-CHUNG HSIEH</u> | , residing at | <u>New Taipei, Taiwan</u> |
| 7. | <u>CHENG-KAI HUANG</u> | , residing at | <u>New Taipei, Taiwan</u> |
| 8. | <u>PAUL CHEN</u> | , residing at | <u>Walnut, CA</u> |
| 9. | <u>GENN-SHENG LEE</u> | , residing at | <u>New Taipei, Taiwan</u> |
| 10. | <u>JIA-HAU LIU</u> | , residing at | <u>New Taipei, Taiwan</u> |
| 11. | <u>MAO-CHUN WENG</u> | , residing at | <u>New Taipei, Taiwan</u> |
| 12. | <u>WAYNE CHOU</u> | , residing at | <u>BREA, CA</u> |

hereby sell(s), assign(s) and transfer(s) unto: (1) **FUDING PRECISION COMPONENTS (SHENZHEN) CO., LTD**, having a principal place of business at **Baoyuan Technology Area, By South Guanguang Road, Guanlan Dashuikeng Village, Longhua District, Shenzhen City, Guangdong Province, China**, and (2) **FOXCONN INTERCONNECT TECHNOLOGY LIMITED** having a principal place of business at **Floor 4, Willow House, Cricket Square, P O Box 2804, Grand Cayman KY1-1112 , Cayman Islands**, hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **INTERCONNECTION SYSTEM WITH HYBRID TRANSMISSION** for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____

[x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and

Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>Shih-Wei Hsiao</u> SHIH-WEI HSIAO	<u>12/24/2018</u> Date
2.	<u>Hsiu-Yuan Hsu</u> HSIU-YUAN HSU	<u>12/24/2018</u> Date
3.	<u>Wei-Chih Lin</u> WEI-CHIH LIN	<u>12/24/2018</u> Date
4.	<u>SHUO-HSIU HSU</u> SHUO-HSIU HSU	<u>12/24/2018</u> Date
5.	<u>YEN-HSU KO</u> YEN-HSU KO	<u>12/24/2018</u> Date
6.	<u>Chih-Chung Hsieh</u> CHIH-CHUNG HSIEH	<u>12/24/2018</u> Date
7.	<u>Cheng-Kai Huang</u> CHENG-KAI HUANG	<u>12/24/2018</u> Date

8.	<u>Paul Chen</u> PAUL CHEN	<u>12/24/2018</u> Date
9.	<u>Genn-Sheng Lee</u> GENN-SHENG LEE	<u>12/24/2018</u> Date
10.	<u>Jia-Hau Liu</u> JIA-HAU LIU	<u>12/24/2018</u> Date
11.	<u>Maohun Weng</u> MAO-CHUN WENG	<u>12/24/2018</u> Date
12.	<u>Wayne Chou</u> WAYNE CHOU	<u>12/24/2018</u> Date